	SPECIFIC	CATIONS	
CUSTOMER	:		
SAMPLE CODI	 E :		
		This Code will be changed whi	le mass production)
MASS PRODU	CTION CODE :	PG640480FRT-	-ANN-I
	Customer	Approved	
Solon Sim	OC Confirmed	Date:	Docimor
Sales Sign	QC Confirmed	Date:	Designer
Sales Sign	QC Confirmed POWERTIP Q.C. CHK		Designer POWERTIP R&D. CHK
Sales Sign Approval For Specific	POWERTIP Q.C. CHK		Designer POWERTIP R&D. CHK
Approval For Specific * This specification is	POWERTIP Q.C. CHK cations Only.	Checked By POWERTIP R&D. CHK	POWERTIP R&D. CHK
Approval For Specific * This specification is Please contact Po	cations Only. s subject to change without no wertip or it's representative be	Checked By POWERTIP R&D. CHK	POWERTIP R&D. CHK
Approval For Specific * This specification is	cations Only. s subject to change without no wertip or it's representative be	Checked By POWERTIP R&D. CHK	POWERTIP R&D. CHK
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Approval For Specific * This specification is Please contact Po Approval For Specific dquarters: , 6th Road, Taichung Industrial P	POWERTIP Q.C. CHK cations Only. s subject to change without no wertip or it's representative be cations and Sample. Powertip Ce LCD Division Park, TEL: 886-4-2355-	Checked By POWERTIP R&D. CHK Potice. Perfore designing your product Porporation TE	POWERTIP R&D. CHK t based on this specification LCM Division: EL: 886-4-2355-8168
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RECORDS OF REVISION

Date	Rev.	Description	Note	Page
2003/04/21	0	Mass Production		

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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	640*480 Dots
LCD Type	FSTN, Negative, Transmissive
Driver Condition	LCD Module: 1/240 Duty , 1/13Bias
Viewing Direction	6 O'clock
Backlight	CCFL B/L
Weight	260g
Interface	Dual 4 bits parallel data input
Other(controller/driver IC)	-

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	197.0 (L) * 145.0 (w) * 11.0 (H)(Max)	mm
Viewing Area	153.0 (L) * 115.74 (w)	mm
Active Area	151.66 (L) * 113.74 (w)	mm
Dot Size	0.217 (L) * 0.217 (w)	mm
Dot Pitch	0.237 (L) * 0.237 (w)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	_	0	6.0	V
LCD Driver Supply Voltage	V_{DD} - V_{EE}	_	0	45	V
Input Voltage	V _{IN}	_	-0.3	V _{DD} +0.3	V
Operating Temperature	T _{OP}	Excluded B/L	-20	70	°C
Storage Temperature.	T _{ST}	Excluded B/L	-30	80	°C
Storage Humidity	H _D	Ta<40 °C	20	60	%RH



1.4 DC Electrical Characteristics

 $V_{DD} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{V}$, $Ta = 25 ^{\circ}\text{C}$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply voltage	VDD	-	3.0	5.0	5.5	V
"H" input voltage	Vıн	-	0.8 Vdd	-	VDD	٧
"L" input voltage	VIL	-	0	-	0.2 VDD	V
"H" output voltage	Vон	lон=-0.4mA	VDD-0.3	-	0.3	٧
"L" output voltage	Vol	IoL=+0.4mA	0	-	0.4	٧
Supply current	I _{DD}	V _{DD} =5V	-	3	-	mA
		V _{DD} - V _O (0°C)	-	23.5	-	
LCM Driver Voltage	V_{OP}	V _{DD} - V _O (25°C)	-	22.3	-	V
		V _{DD} - V _O (50°C)	-	20.5	-	

1.5 Optical Characteristics

LCD Panel : 1/240 Duty , 1/13 Bias , V_{LCD} = 22.3V , Ta = 25 $^{\circ}$ C

Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	θ	C <u>></u> 2.0,∅= 0°	-22°	-	37°	Notes 1 & 2
Contrast Ratio	C	θ= 5°, Ø= 0°	-	4	-	Note 3
Response Time(rise)	tr	θ= 5°, Ø= 0°	-	150 ms	-	Note 4
Response Time(fall)	tf	θ= 5°, Ø= 0°	-	200 ms	-	Note 4
Luminance (LCM)	L	-	100	120	-	Cd/m ²



Note 1: Definition of angles θ and \emptyset

Light (when reflected) $z (\theta=0^{\circ})$

Sensor θ Y'(\emptyset =180°) \searrow LCD panel $X(\emptyset$ =90°)

Light (when transmitted) $Y(\varnothing=0^{\circ})$ $(\theta=90^{\circ})$

Note 3: Definition of contrast C

C = -

Brightness (reflection) of unselected dot (B2)

Brightness (reflection) of selected dot (B1)

Brighness (reflection) of selected dot

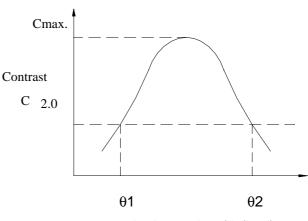
(%)

Brightness
(reflection) of unselected dot

(reflection)

operating voltage (v)

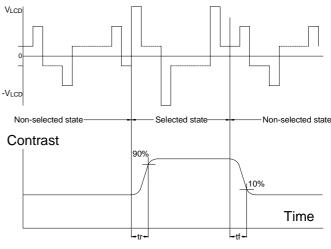
Note 2: Definition of viewing angles θ 1 and θ 2



viewing angle θ (\varnothing fixed)

Note : Optimum viewing angle with the $naked\ eye\ and\ viewing\ angle\ \theta\ at$ $Cmax.\ Above\ are\ not\ always\ the\ same$

Note 4: Definition of response time



Note:Measured with a transmissive LCD panel which is displayed 1 cm²

$$\begin{split} &V_{LCD}: Operating \ voltagef_{FRM}: Frame \ frequency \\ &t_r \quad : Response \ time \ (rise) \quad t_f: Response \ time \ (fall) \end{split}$$



1.6 Backlight Characteristics

LCD Module with CCFL Backlight

Electrical Characteristics

Item	Symbol	Conditions	Spec		Unit
Lamp current	lμ	Ta=25°ℂ	5 ±	5 ± 1.0	
Lamp voltage	V_{L}	Ta=25°ℂ	29	95	V_{rms}
Lamp Frequency	FL	Ta=25°ℂ	55		KHz
Lamp Power	PL	Ta=25°C	1.5		W _{rms}
Lamp Life Time	Hr	> 15			
Operating Temperature	T _{OP}	20~90%RH	0	60	$^{\circ}\!\mathbb{C}$
Storage temperature	T _{ST}	5~90%RH	-30	70	$^{\circ}\!\mathbb{C}$

Optical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Average Brightness (With LCD)	IV	Note1	1	233	-	cd/m ²
Brightness Uniformity	-	Note1	70%	85%	100%	
Color	White					

Note1: Inverter use TDK CXA-L10A (Power Supply 5.0V) at Ta=25℃



2. MODULE STRUCTURE

2.1 Counter Drawing

* See Appendix

2.2 Interface Pin Description

LCM Connector: MOLEX 53261-1590

Pin No.	Symbol	Level	Function
1	FLM	Н	The FLM signal indicating the beginning of each display cycle
2	LP	H->L	Display data latch pulse
3	CL2	H->L	Display data shift clock
4	/DISP	H/L	'H': Display ON; 'L': Display OFF
5	VDD		Power supply for logic curcuit
6	VSS		Ground
7	VEE		Contrast adjustment voltage , VEE-VSS=22.5 V at 25°C
8~11	UD0~UD3	H/L	Upper Screen Display data
12~15	LD0~LD3	H/L	Lower Screen Display data

Mating connector:

MOLEX 51021-1500(HOUSING)*1 + MOLEX 50058-8000(TERMINAL)*15

CCFL Connector: MITSUMI: M63-M83-04

Interface	Pin	Signal	Function
CCFL	1	VCCFL	Power supply for CCFL back light
Back	2~3	NC	No connection
Light	4	VCCFL	Power supply for CCFL back light

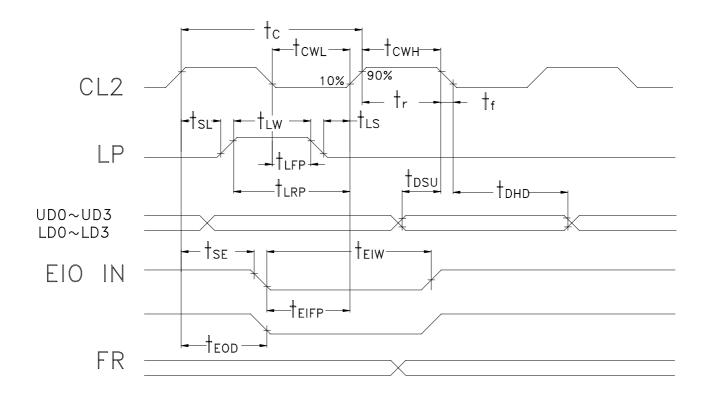
Mating connector:

MITSUMI: M61M73-04/M60-04-30-114P(STRAIGHT)/ M60-04-30-134P(ANGLE)



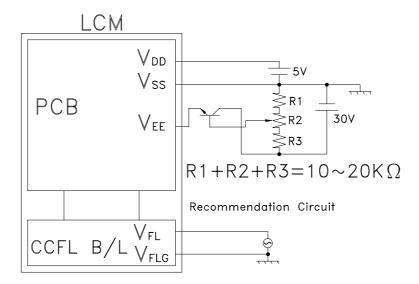
2.3 Timing Characteristics

ITEM	Symbol	TEST CONDITIONS	Min	Max	Units
Clock Cycle	tc	-	125	-	ns
CL2 Pulse Width	TcwH, tcwL	-	50	-	ns
DATA Set-up Time	tDSU	-	50	-	ns
DATA Hold Time	tDHD	-	50	-	ns
CL2 Rise/Fall Time	tr,tf	-	-	(*5)	ns
LP Rise Time	tLRP	-	50	-	ns
LP Fall Time	tLFP	-	50	-	ns
LP Pulse Width	tLW	-	45	-	ns
CL2-to-LP Delay Time	tSL	-	40	-	ns
LP-to- CL2 Delay Time	tLS	-	40	-	ns
EIO-in Fall Time	tEIFP	-	40	-	ns
EIO-in Pulse Width	tEIW	-	40	-	ns
CL2-to-EIP Delay Time	tSE	-	20	-	ns
EIO-out Delay Time	tEOD	(*6)	-	80	ns

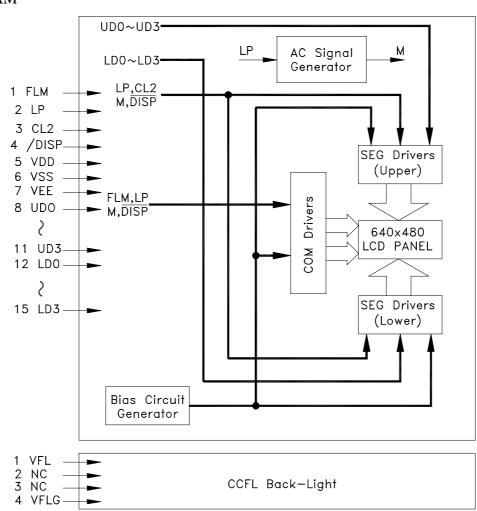




POWER SUPPLY

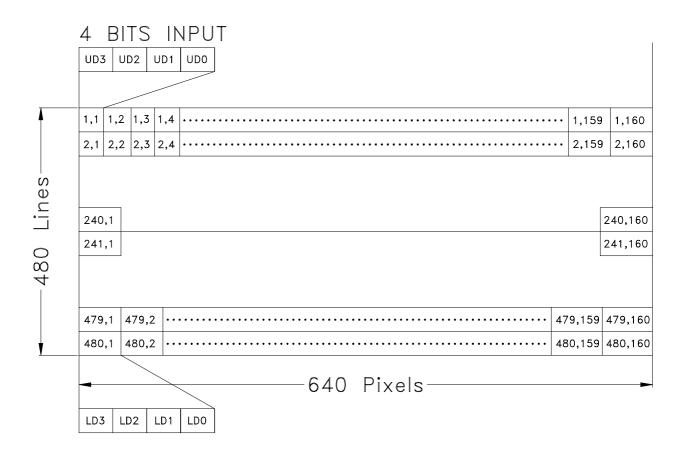


BLOCK DIAGRAM





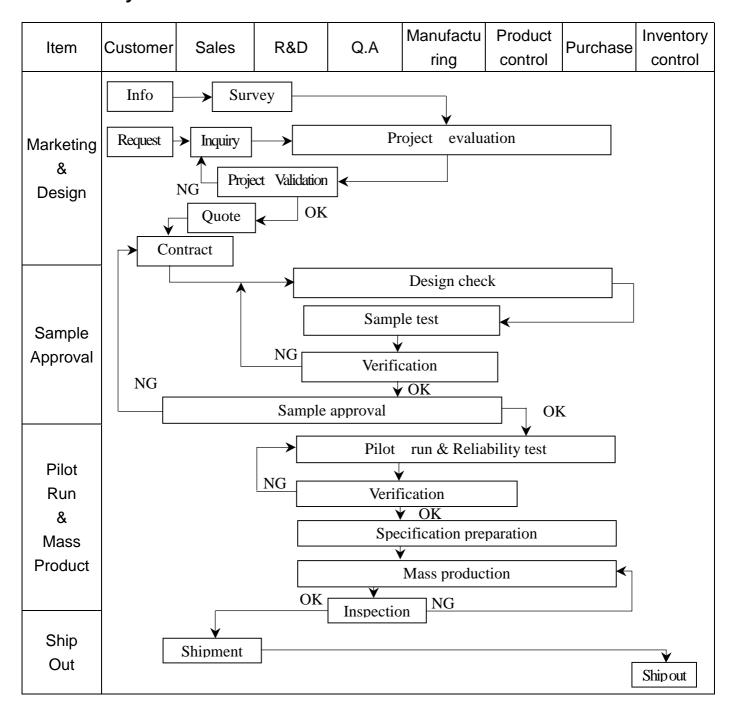
DISPLAY PATTERN



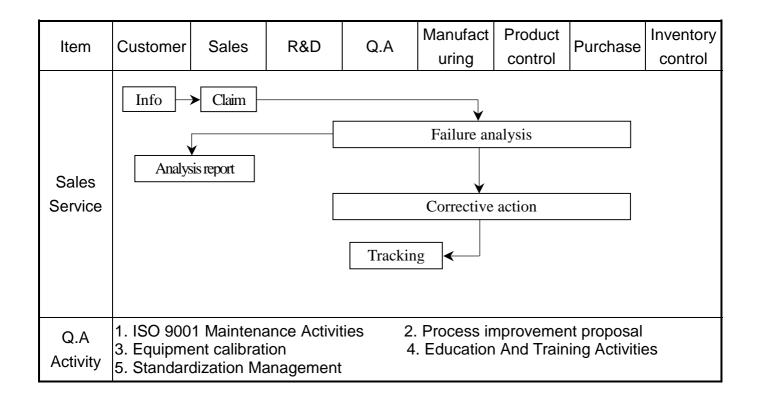


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

Equipment: Gauge · MIL-STD · Powertip Tester · Sample · IQC Defect Level: Major Defect AQL 0.4; Minor Defect AQL 1.5 ·

FQC Defect Level: 100% Inspection • OUT Going Defect Level: Sampling •

Specification:

NO	Item	Specification		Level
1	Part Number The part number is inconsistent with work order of production		N.G.	Major
2	Quantity The quantity is inconsistent with work orde production		N.G.	Major
	Electronic characteristics of LCM A=(L + W) ÷ 2	The display lacks of some patterns.	N.G.	Major
		Missing line.	N.G.	Major
3		The size of missing dot, A is > 1/2 Dot size	N.G.	Major
		There is no function.	N.G.	Major
		Output data is error	N.G.	Major
		Material is different with work order of production	N.G.	Major
		LCD is assembled in inverse direction	N.G.	Major
		Bezel is assembled in inverse direction	N.G.	Major
		Shadow is within LCD viewing area + 0.5 mm	N.G.	Major
	Appearance of	The diameter of dirty particle, A is > 0.4 mm	N.G.	Minor
	LCD A=(L+W)÷2 Dirty particle (Including scratch · bubble)	Dirty particle length is $>$ 3.0mm, and 0.01mm $<$ width \leq 0.05mm	N.G.	Minor
4		Display is without protective film	N.G.	Minor
		Conductive rubber is over bezel 1mm	N.G.	Minor
		Polarizer exceeds over viewing area of LCD	N.G.	Minor
		Area of bubble in polarizer, $A > 1.0$ mm, the number of bubble is > 1 piece.	N.G.	Minor
		0.4mm < Area of bubble in polarizer, A < 1.0mm, the number of bubble is >4 pieces.	N.G.	Minor
	Appearance of PCB A=(L + W) ÷ 2	Burned area or wrong part number is on PCB	N.G.	Major
		The symbol, character, and mark of PCB are unidentifiable.	N.G	Minor
		The stripped solder mask , A is>1.0mm	N.G.	Minor
		0.3mm < stripped solder mask or visible circuit, A $<$ 1.0mm, and the number is \ge 4 pieces	N.G.	Minor
5		There is particle between the circuits in solder mask	N.G	Minor
		The circuit is peeled off or cracked	N.G	Minor
		There is any circuits risen or exposed.	N.G	Minor
		0.2 mm $<$ Area of solder ball, A is ≤ 0.4 mm The number of solder ball is ≥ 3 pieces	N.G	Minor
		The magnitude of solder ball, A is $>$ 0.4mm.	N.G	Minor



NO	Item	Specification		Level
	Appearance of molding A=(L + W) ÷ 2	The shape of modeling is deformed by touching.	N.G.	Major
6		Insufficient epoxy: Circuit or pad of IC is visible	N.G.	Minor
		Excessive epoxy: Diameter of modeling is >20mm or height is >2.5mm	N.G.	Minor
		The diameter of pinhole in modeling, A is > 0.2 mm.	N.G.	Minor
	Appearance of frame A=(L+W)÷2	The folding angle of frame must be $>45^{\circ}$ +10°	N.G.	Minor
7		The area of stripped electroplate in top-view of frame, A is $>$ 1.0mm.	N.G.	Minor
'		Rust or crack is (Top view only)	N.G.	Minor
		The scratched width of frame is > 0.06mm. (Top view only)	N.G.	Minor
	Electrical	The color of backlight is nonconforming	N.G.	Major
	characteristic of	Backlight can't work normally.	N.G.	Major
8	backlight	The LED lamp can't work normally	N.G.	Major
	A=(L + W) ÷ 2	The unsoldering area of pin for backlight, A is >1/2 solder joint area.	N.G.	Minor
		The height of solder pin for backlight is >2.0mm	N.G.	Minor
	Assembly parts A=(L + W) ÷ 2	The mark or polarity of component is unidentifiable.	N.G.	Minor
		The height between bottom of component and surface of the PCB is floating >0.7mm	N.G.	Minor
10		D>1/4W W D D D' Pad	N.G.	Minor
		End solder joint width, D' is >50% width of component termination or width of pad	N.G.	Minor
		Side overhang, D is $>$ 25% width of component termination.	N.G.	Minor
		Component is cracked, deformed, and burned, etc.	N.G.	Minor
		The polarity of component is placed in inverse direction.	N.G.	Minor
		Maximum fillet height of solder extends onto the component body or minimum fillet height is <0.5mm.	N.G.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO	Item	Test Condition		
1	High Temperature Storage	Storage at 80 ±2°C 96~100 hrs		
		Surrounding temperature, then storage at normal condition		
		4hrs		
	Low Temperature Storage	Storage at -30 ±2°C 96~100 hrs		
2		Surrounding temperature, then storage at normal condition		
		4hrs		
	High Temperature /Humidity Storage	1.Storage 96~100 hrs 60 ±2°C, 90~95%RH surrounding		
3		temperature, then storage at normal condition 4hrs.		
		(Excluding the polarizer).		
		2.Storage 96~100 hrs 40 ±2°C, 90~95%RH surrounding		
		temperature, then storage at normal condition 4 hrs.		
	Temperature Cycling	$-20^{\circ} \text{C} \rightarrow 25^{\circ} \text{C} \rightarrow 70^{\circ} \text{C} \rightarrow 25^{\circ} \text{C}$ (20mins) (5mins) (5mins)		
4		(30mins) (5mins) (30mins) (5mins)		
		10 Cycle		
	Vibration	40 5511 /4		
5		10~55Hz (1 minute) 1.5mm		
		X,Y and Z direction * (each 2hrs)		
	ESD Test	Air Discharge:	Contact Discharge:	
		Apply 6 KV with 5 times	Apply 250V with 5 times	
6		discharge for each polarity +/-	discharge for each polarity +/-	
0		Testing location: Around the face of LCD	Testing location:	
			1.Apply to bezel.	
			2.Apply to Vdd, Vss.	
	Drop Test	Packing Weight (Kg)	Drop Height (cm)	
		0 ~ 45.4	122	
7		45.4 ~ 90.8	76	
		90.8 ~ 454	61	
		Over 454	46	



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



